

BB173 VHF variable capacitance diode Rev. 1 — 25 March 2013

**Product data sheet** 

# 1. Product profile

### 1.1 General description

The BB173 is a variable capacitance diode, fabricated in planar technology, and encapsulated in the SOD523 (SC-79) ultra small SMD plastic package.

### 1.2 Features and benefits

- Excellent linearity
- Ultra small SMD plastic package
- $C_{d(28V)} = 2.6 \text{ pF}; C_{d(1V)} \text{ to } C_{d(28V)} \text{ ratio} = 15$
- Very low series resistance

### **1.3 Applications**

Voltage Controlled Oscillators (VCO)

## 2. Pinning information

Pin	Description	Simplified outline	Symbol
1	cathode	[1]	
2	anode	1 2	$\downarrow$
			sym008

[1] The marking bar indicates the cathode.

# 3. Ordering information

### Table 2.Ordering information

Type number	Package				
	Name	Description	Version		
BB173	SC-79	plastic surface-mounted package; 2 leads	SOD523		



## 4. Marking

Table 3. Marking	
Type number	Marking code
BB173	CE

# 5. Limiting values

### Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>R</sub>	reverse voltage		-	32	V
		peak value in series with a 10 $k\Omega$ resistor	-	35	V
I <sub>F</sub>	forward current		-	20	mA
T <sub>stg</sub>	storage temperature		-55	+150	°C
Tj	junction temperature		-55	+125	°C

## 6. Characteristics

### Table 5.Characteristics

 $T_i = 25 \ ^{\circ}C$  unless otherwise specified.

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
I <sub>R</sub>	reverse current	V <sub>R</sub> = 30 V	[1]	-	-	10	nA
		$V_R = 30 \text{ V}; \text{ T}_j = 85 ^{\circ}\text{C}$	[1]	-	-	200	nA
r <sub>s</sub>	diode series resistance	$f = 100 \text{ MHz}; C_d = 30 \text{ pF}$		-	0.65	0.8	Ω
C <sub>d</sub>	diode capacitance	f = 1 MHz	[2]				
		V <sub>R</sub> = 1 V		34.65	-	42.35	pF
		V <sub>R</sub> = 28 V		2.361	2.6	2.754	pF
$C_{d(1V)}/C_{d(2V)}$	diode capacitance ratio (1 V to 2 V)	f = 1 MHz		-	1.3	-	
$C_{d(1V)}/C_{d(28V)}$	diode capacitance ratio (1 V to 28 V)	f = 1 MHz		13.5	15	-	
$C_{d(25V)}/C_{d(28V)}$	diode capacitance ratio (25 V to 28 V)	f = 1 MHz		-	1.08	-	

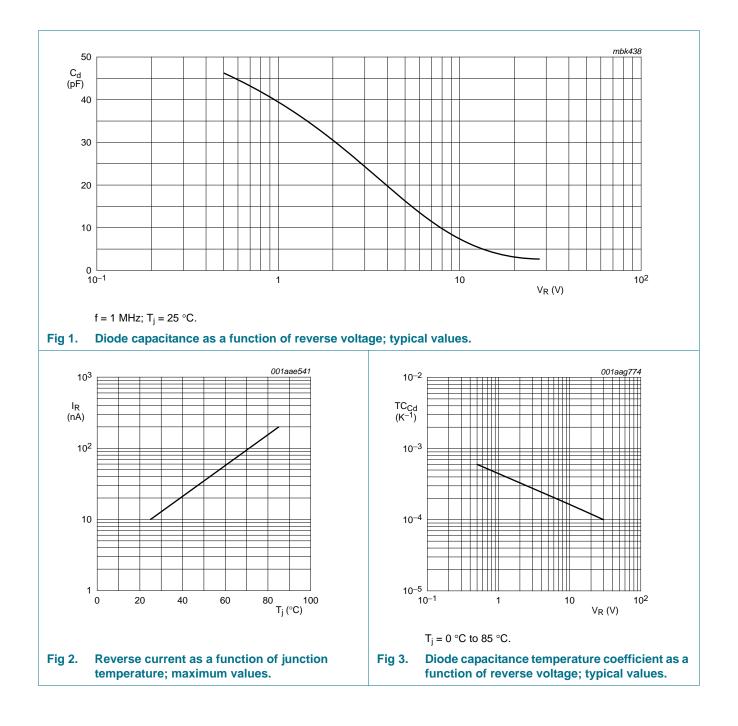
[1] See Figure 2.

[2] See <u>Figure 1</u> and <u>Figure 3</u>.

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#### 7. **Package outline**

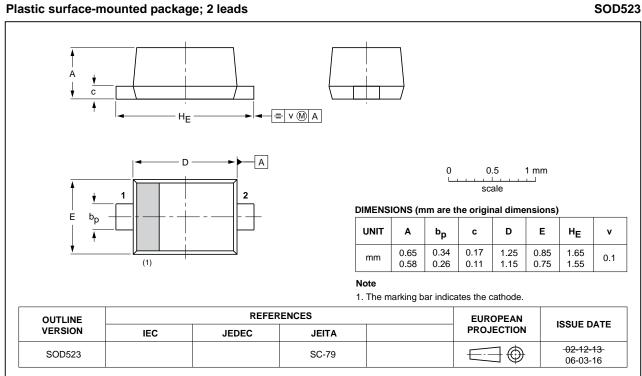


Fig 4. Package outline SOD523 (SC-79)

### **SOD523**

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# 8. Abbreviations

Table 6.	Abbreviations
Acronym	Description
SMD	Surface Mounted Device
VHF	Very High Frequency

# 9. Revision history

Table 7. Revision his	tory			
Document ID	Release date	Data sheet status	Change notice	Supersedes
BB173 v.1	20130325	Product data sheet	-	-

# **10. Legal information**

### **10.1** Data sheet status

Document status[1][2]	Product status <sup>[3]</sup>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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